



(12) EUROPEAN PATENT APPLICATION

(43) Date of publication:
27.01.1999 Bulletin 1999/04

(51) Int. Cl.⁶: G01L 21/12

(21) Application number: 98102089.4

(22) Date of filing: 06.02.1998

(84) Designated Contracting States:
AT BE CH DE DK ES FI FR GB GR IE IT LI LU MC
NL PT SE
Designated Extension States:
AL LT LV MK RO SI

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(30) Priority: 21.07.1997 US 897629

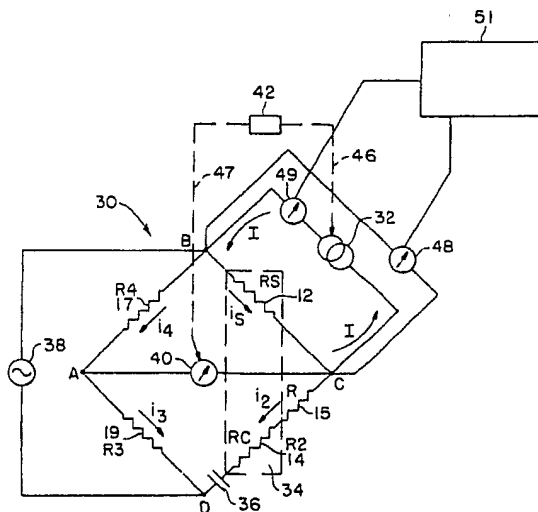
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(54) Apparatus and methods for heat loss pressure measurement

(57) An improved Pirani gauge has a small-diameter wire sensing element, coplanar with a small-diameter wire compensating element, with two parallel flat thermally conductive plates spaced from the sensing and compensating elements. The sensing (12) and compensating elements (14) and their connections have the same physical dimensions, thermal properties and resistance properties. The connections have large thermal conductances to a uniform temperature region and the elements are located in the same vacuum environment. A DC heating current (32) is used and confined to only the sensing elements (12). A relatively small AC signal (32,40) is used to sense bridge balance. A simplified three-dimensional pressure compensation formula (5) provides accurate compensation while simplifying the collection of calibration data. The improved gauge provides significant advancements in Pirani gauge accuracy, production cost, and package size.

FIG. 6



Description

FIELD OF THE INVENTION

5 The present invention relates to a heat loss gauge utilizing gas conduction for measuring pressures, ranging from very low pressures to pressures greater than atmospheric pressure.

BACKGROUND OF THE INVENTION

10 Because the rate of heat transfer through a gas is a function of the gas pressure, under certain conditions measurements of heat transfer rates from a heated sensing element to the gas can, with appropriate calibration, be used to determine the gas pressure. This principle is used in the well known Pirani gauge (shown in schematic form in Figs. 1a and 1b), in which heat loss is measured with a Wheatstone bridge network which serves both to heat the sensing element and to measure its resistance.

15 Referring to Figure 1a, in a Pirani gauge the pressure sensor consists of a temperature sensitive resistance RS connected as one arm of a Wheatstone bridge. R2 is typically a temperature sensitive resistance designed to have a negligible temperature rise due to the current i_2 . R3 and R4 are typically fixed resistances. RS and typically R2 are exposed to the vacuum environment whose pressure is to be measured. Figure 1b illustrates an alternative bridge configuration.

20 Pirani gauges have been operated with constant current i_1 (as shown in U.S. Patent 3,580,081), or with constant voltage across RS. In these methods, an electrical imbalance of the bridge is created which reflects gas pressure. Pirani gauges have also been operated with constant resistance RS (as shown in U.S. Patent 2,938,387). In this mode, the rate at which energy is supplied is varied with changes in gas pressure, so the rate of change in energy supplied reflects changes in gas pressure. Each method of operation has differing advantages and disadvantages, but the following discussion pertains particularly to the constant resistance method and the configuration of Figure 1a.

25 Voltage V_B is automatically controlled to maintain the voltage difference between A and C in Fig. 1a at zero volts. When the potential drop from A to C is zero, the bridge is said to be balanced. At bridge balance the following conditions exist:

$$30 \quad i_5 = i_2, \quad (1)$$

$$35 \quad i_4 = i_3 \quad (2)$$

$$\text{and} \quad i_5 RS = i_4 R4, \quad (3)$$

$$40 \quad i_2 R2 = i_3 R3 \quad (4)$$

45 Dividing Eq. 3 by Eq. 4 and using Eq. 1 and 2 gives

$$RS = \beta R2 \quad (5)$$

$$50 \quad \text{where} \quad \beta = \frac{R4}{R3} \quad (6)$$

Thus, at bridge balance RS is a constant fraction β of R2.

55 To achieve a steady state condition in RS at any given pressure, Eq. 7 must be satisfied:

$$\text{Electrical power input to RS} = \text{Power radiated by RS} + \text{Power lost out ends of RS} + \text{Power lost to gas by RS} \quad (7)$$

A conventional Pirani gauge is calibrated against several known pressures to determine a relationship between unknown pressure, P_x , and the power loss to the gas or more conveniently to the bridge voltage. Then, assuming end losses and radiation losses remain constant, the unknown pressure of the gas P_x may be directly determined by the power lost to the gas or related to the bridge voltage at bridge balance.

Because Pirani gauges may be designed to have wide range and are relatively simple and inexpensive, there is a long-felt need to be able to use these gauges as a substitute for much higher priced gauges such as capacitance manometers and ionization gauges. However, existing designs leave much to be desired for accurate pressure measurement, especially at lower pressures.

Prior to 1977, the upper pressure limit of Pirani gauges was approximately 20 Torr due to the fact that at higher pressures the thermal conductivity of a gas becomes substantially independent of pressure in macroscopic size devices. One of the present inventors helped develop the CONVECTRON® Gauge produced and sold by the assignee (Granville-Phillips Company of Boulder Colorado) since 1977 which utilizes convection cooling of the sensing element to provide enhanced sensitivity from 20 to 1,000 Torr. Hundreds of thousands of CONVECTRON® Gauges have been sold worldwide. Recently several imitations have appeared on the market.

Although the CONVECTRON® Gauge filled an unsatisfied need, it has several disadvantages. It has by necessity large internal dimensions to provide space for convection. Therefore, it is relatively large. Because convection is gravity dependent, pressure measurements at higher pressures depend on the orientation of the sensor axis. Also, because the pressure range where gas conduction cooling is predominant does not neatly overlap the pressure range where convection cooling occurs, the CONVECTRON® Gauge has limited sensitivity from approximately 20 to 200 Torr.

To help avoid these difficulties, microminiature Pirani sensors have been developed which utilize sensor-to-wall spacings on the order of a few microns rather than the much larger spacings, e.g., 0.5 in., previously used. See for example U.S. Patents 4,682,503 to Higashi et al. and 5,347,869 to Shie et al. W. J. Alvesteffer et al., in an article appearing in J. Vac. Sci. Technol. A 13(6), Nov/Dec 1995, describe the most recent work on Pirani gauges known to the present inventors. Using such small sensor to wall spacings provides a pressure dependent thermal conductivity even at pressures above atmospheric pressure. Thus, such microscopic sensors have good sensitivity from low pressure to above atmospheric pressure and function in any orientation.

There are a number of problems with previous attempts to develop microminiature gauges. Although microminiature sensors provide good sensitivity over a large pressure range independent of orientation, their design is extremely complex and fabrication requires numerous elaborate processing steps in highly specialized equipment costing hundreds of thousands of dollars.

Microminiature sensors suffer from the same type of ambient temperature-caused errors as do macroscopic sensors. All of the heat loss terms in Eq. 7 are dependent on ambient temperature and on sensing element temperature at any given pressure. Thus, any attempt at pressure measurement with a Pirani gauge without temperature correction will be confused by non-pressure dependent power losses caused by changes in ambient temperature. All modern Pirani gauges attempt to correct for the errors caused by ambient temperature changes. A widely used means for correcting for such errors is to use for R2 a temperature sensitive compensating element RC in series with a fixed resistance R, as shown in Figs. 1a and 1b.

British Patent GB 2105047A discloses the provision of an additional resistor to provide a potential divider. J.H. Leck, at page 58 of Pressure Measurement in Vacuum, Chapman and Hall: London (1964) notes that Hale in 1911 made R2 of the same material and physical dimensions as RS in his Pirani gauge. R2 was sealed off in its own vacuum environment and placed in close proximity to RS. When the pressures at R2 and RS were equal, excellent temperature compensation was achieved. However, at other pressures this means of temperature compensation is not very effective.

To avoid the extra cost and complexity of evacuating and sealing off R2 in a separate bulb, R2 is conventionally placed in the same vacuum environment as RS. By making R2 with a relatively large thermal mass and large thermal losses, self heating of R2 can be made negligible. Leck recommends that R2 be "made in two sections, for example, one of copper and the other Nichrome wire . . . so that the overall temperature coefficient (of R2) just matches that of the Pirani element itself (RS)." According to Leck, this method of temperature compensation has been used by Edwards High Vacuum of Great Britain in the METROVAC® brand gauge. A similar temperature compensation arrangement is used in the CONVECTRON® brand gauge.

However, this technique (using two or more materials in R2 having different temperature coefficients of resistance to approximate the temperature coefficient of RS) is effective only over a narrow range of pressure. In fact the compensation can be made exact only at one, or at most several temperatures as noted in U.S. Patent 4,541,286, which discloses this form of temperature compensation in a Pirani gauge. Also, the inventors have found that configurations with a large thermal mass significantly increase the response time of the gauge to sudden changes in ambient temperature.

The inventors have also found, through extensive computer simulation, that using equal temperature coefficients for RS and R2 as recommended by Leck and as practiced in the prior art does not provide an entirely accurate temperature compensation. The inventors have also found that at pressures less than approximately 5×10^{-3} Torr, the end

losses exceed all other losses combined. The relative loss components as determined by this research (radiation loss, end loss and gas loss components of total loss) are shown in the graph of Fig. 2. At 1×10^{-5} Torr, the end losses are over 1000 times greater than the gas loss and radiation losses are approximately 100 times greater than the gas loss.

Therefore, temperature change effects in prior art Pirani Gauges are especially troublesome at very low pressures where gas conduction losses are very low. Prior art heat loss gauges cannot measure very low pressures accurately, for example, 1×10^{-5} Torr. The inventors have discovered that this limitation is a result of failure to maintain end losses in the sensing element sufficiently constant when ambient temperature changes. The Alvesteffer-type Pirani gauge has the capability of indicating pressure in the 10^{-5} Torr range, but does not provide an accurate indication within that range. For example, if the end losses are not held constant to one part in 5,000 in a typical Pirani gauge, a pressure indication at 1×10^{-5} Torr may be off by 50% to 100%.

The following analysis shows why prior art designs are ill-suited to correct adequately for ambient temperature changes at low pressures. For convenience in examining the prior art, the problems are explained using examples of gauges with relatively large spacing of sensor element to wall. It should be understood that the same type of problems exist in the much more complex geometries of microminiature gauges, with sensing element-to-wall spacings on the order of a few microns.

Fig. 3 is a schematic representation of a portion 302 of a conventional Pirani gauge using a small diameter wire sensing element 304 and a compensating element 303. Those familiar with Pirani gauge design will appreciate that the components in Fig. 3 are not shown to scale, for ease of explanation and understanding. Typically, small diameter wire sensing element 304 is electrically and thermally joined to much larger electrical connectors 306, 307 which are thermally joined to much larger support structures 308, 309. Let T_{AL} represent the temperature in support structure 308 at the left end of sensing element 304 and T_{AR} represent the temperature in support structure 309 at the right end at any given time t . Let T_{SL} and T_{SR} represent the temperatures at left sensing element connector 306 and right sensing element connector 307 respectively. Let T_{CL} and T_{CR} represent the temperatures at left compensating element connector 310 and right compensating element connector 311 respectively. Let T_{XL} and T_{XR} represent the temperatures a distance ΔX from connectors 306 and 307 respectively. In prior art designs, it has apparently been assumed that all of these temperatures are the same. However, the inventors have found that even seemingly negligible differences assume great importance for low pressure accuracy.

To better understand temperature compensation requirements, it is important to note several facts.

(1) At low pressures, the temperature of RC is determined predominantly by heat exchange between the compensating element connections and the compensating element. This is because at ambient temperature and low pressures, radiation and gas conduction are very inefficient means of exchanging heat from the compensating element to its surroundings relative to heat conduction through the ends of the compensating element. Thus, at low pressures the compensating element temperature will be very close to the average of the temperatures of the connectors at each end of the compensating element as shown in Eq. 8.

$$T_{AVG} = \frac{T_{CL} + T_{CR}}{2} \quad (8)$$

(2) The temperature of the electrically heated sensing element varies from the ends to center, increasing with distance from the cooler supports. Using finite element analysis the inventors have simulated the temperature distribution along the sensing element. It has been found that with equal temperature coefficients of resistance for RS and RC, the temperature T_n of any segment n of the sensing element changes with changes in average temperature T_{AVG} of the compensating element RC at constant pressure at bridge balance so as to maintain a constant difference $\Delta T_n = T_n - T_{AVG}$. The difference ΔT_n is a function of β and R where $R = R_2 - R_C$.

(3) According to Eq. 5, the sensing element resistance RS at bridge balance will be maintained at a resistance β times the resistance element R2. As the ambient temperature increases, the compensating element connectors also increase in temperature and thus the temperature and resistance of RC will increase according to Eq. 8. Any increase in the temperature and therefore the resistance of RC causes an increase in the temperature and resistance of all segments of RS at bridge balance.

(4) The power losses out the ends of the sensing element depend on the temperature gradient γ at the ends of the sensing element according to Eq. 9:

$$\text{Power lost out end} = k \gamma \quad (9)$$

where k is a constant and

$$\gamma_L = \frac{T_{XL} - T_{SL}}{\Delta X} \quad \text{at left end} \quad (10)$$

$$\gamma_R = \frac{T_{XR} - T_{SR}}{\Delta X} \quad \text{at right end.} \quad (11)$$

If γ_L and or γ_R vary for any reason, then the end losses will change and the pressure indication will be erroneous.

To understand in detail a significant deficiency in the prior art of temperature compensation at low pressures, assume that from a steady state, T_{AR} is increased slightly for example by changes in the local ambient temperature environment of the right support structure. Assume T_{AL} remains unchanged. Because T_{AL} is assumed not to change, T_{CL} and T_{SL} will remain unchanged. However, the increase in T_{AR} will cause T_{CR} to increase by conduction of heat through the connection. Thus,

$$T_{AVG} = \frac{T_{CL} + T_{CR}}{2}$$

will increase. An increase in T_{AVG} will cause an increase in T_{XL} and T_{XR} at bridge balance, which will produce changes in γ_L and γ_R . These changes in γ_L and γ_R will change the end loss term in Eq. 7, causing an error in pressure measurement dependent on the size of the changes in γ_L and γ_R .

The inventors have determined that unless T_{AL} changes in substantially the same way as T_{AR} , sensing element end losses will not remain unchanged whenever ambient temperature changes. Prior art Pirani gauges have not been specifically designed to maintain $T_{AL} = T_{AR}$ to the degree necessary for accurate low pressure measurement.

To understand another important deficiency in prior art temperature compensation, assume that from a steady state, ambient temperature is increased and that ambient temperature conditions are such that $T_{AL} = T_{AR}$. Further assume the sensing element connectors are of equal length but that the right compensating element connector is substantially longer than the left compensating element connector as is the case in a popular prior art Pirani gauge. Thus, $T_{SL} = T_{SR}$ but T_{CR} will lag behind T_{CL} because of the assumed differences in length. During this lag time when $T_{CL} \neq T_{CR}$, T_{AVG} will change, thus changing T_{XL} and T_{XR} at bridge balance. Thus, γ_L and γ_R will continually change during the lag time, producing errors in low pressure indication.

The inventors have determined that unless the sensing element and compensating element connectors have substantially identical physical dimensions and substantially identical thermal properties, sensing element end losses will not remain unchanged when ambient temperature changes. Prior art Pirani gauges have not been specifically designed so that sensing and compensating element connectors have identical physical dimensions and thermal properties.

Another significant deficiency arises (as the inventors have discovered) from differences in mass between the compensating element and the sensing element. Assume that the mass of the compensating element is substantially larger than that of the sensing element as is typically the case. With prior art Pirani gauges it is common practice to make the compensating element large relative to the sensing element and to provide a relatively large heat loss path to the compensating element surroundings so that the heat arising from dissipation of electrical power in RC can be readily dispersed. From a steady state, assume that ambient temperature increases and that $T_{AL} = T_{AR}$ at all times. Thus, it will take a longer time for the compensating element to reach a new steady state temperature relative to the time it will take T_{SL} and T_{SR} to reach a new steady state temperature. During this time (which has been observed to be of several hours duration in a popular prior art Pirani gauge) T_{AVG} will continually change, thus continually changing T_{XL} and T_{XR} at bridge balance. Thus, γ_L and γ_R will change during the lag time, sensing element end losses will not remain constant, and errors will be produced in low pressure measurement.

The same type of problems occur if the compensating element is designed to change temperature at a different rate than does the sensing element with change in ambient temperature at bridge balance. Prior art designs such as the Alvesteffer-type device have this deficiency.

From their research, the inventors have determined that, unless the compensating element has been designed to change temperature at the same rate as the sensing element, sensing element end losses continue to change long after ambient temperature has stabilized at a new value. Yet, prior art Pirani gauges have not been designed to meet

this requirement.

It has long been known to use for R2 a compensating element RC, with substantially the same temperature coefficient of resistance as the sensing element, in series with a temperature insensitive resistance element R so as to provide temperature compensation for gas losses and end losses which vary as the temperature difference between the sensing element and its surroundings. This method of temperature compensation has been employed in the CONVECTRON® Gauge for many years and is also used in the Alvesteffer gauge.

This method of temperature compensation assumes that if (1) the temperature coefficients of resistance of the sensing and compensating elements are equal; and (2) the change in sensing element resistance can be made to rise in tandem with change in compensating element resistance, then (3) the temperature of the sensing element will rise in tandem with ambient temperature changes. Satisfying these two assumptions is highly desirable, of course, because doing so would assure that the temperature difference between the heated sensing element and the surrounding wall at ambient temperature would remain constant as ambient temperature changes.

However, the inventors have found that prior art gauges which utilize a constant resistance R in series with a temperature sensitive resistance RC for R2 provide only partial temperature compensation as will now be explained.

Assume that in Fig. 1a, R2 is composed of a temperature sensitive compensating element RC and a temperature insensitive resistance R so that

$$R2 = RC + R \quad (12)$$

Thus, Eq. 5 derived above for bridge balance may be written as

$$RS = \beta (RC + R) \quad (13)$$

where β is defined by Eq. 6 above.

Further, assume when the ambient temperature environment of the gauge is equal to T_1 that the sensing element operates at temperature T_{S1} and the compensating element operates at temperature T_{C1} . Thus when

$$T_{\text{AMBIENT}} = T_1 \quad (14)$$

Eq. 13 may be written as

$$RS(T_1) (1 + \alpha_s (T_{S1} - T_1)) = \beta [RC(T_1) (1 + \alpha_c (T_{C1} - T_1)) + R] \quad (15)$$

Here, $RS(T_1)$ is the resistance of the sensing element at temperature T_1 , α_s is the temperature coefficient of resistance of RS at T_1 , $RC(T_1)$ is the resistance of the compensating element at temperature T_1 , and α_c is the temperature coefficient of resistance of R_C at T_1 . Thus, when

$$T_{\text{AMBIENT}} = T_2$$

Eq. 13 may be written as

$$RS(T_1) (1 + \alpha_s (T_{S2} - T_1)) = \beta [RC(T_1) (1 + \alpha_c (T_{C2} - T_1)) + R] \quad (16)$$

Solving Eq. 15 for T_{S1} gives

$$T_{S1} = \left[\frac{\beta}{RS(T_1)} [RC(T_1)(1 + \alpha_c (T_{C1} - T_1)) + R] - 1 \right] / \alpha_s + T_1 \quad (17)$$

Solving Eq. 16 for T_{S2} gives

$$T_{s2} = \left[\frac{\beta}{RS(T_1)} [RC(T_1)(1 + \alpha_c(T_{c2} - T_1)) + R] - 1 \right] / \alpha_s + T_1 \quad (18)$$

Subtracting Eq. 17 from Eq. 18 gives the temperature change ΔT in the sensing element RS when ambient temperature changes from T_1 to T_2 . Thus,

$$\Delta T = T_{s2} - T_{s1} = \beta \left(\frac{RC(T_1)}{RS(T_1)} \right) \left(\frac{\alpha_c}{\alpha_s} \right) (T_{c2} - T_{c1}) \quad (19)$$

Note that an effective compensating element is designed so that its temperature closely follows ambient temperature. Thus, to a very good approximation,

$$T_{c2} - T_2 = T_{c1} - T_1$$

or

$$T_{c2} - T_{c1} = T_2 - T_1 \quad (20)$$

Thus, Eq. 19 may be written as

$$\Delta T = \beta \left(\frac{RC(T_1)}{RS(T_1)} \right) \left(\frac{\alpha_c}{\alpha_s} \right) (T_2 - T_1) \quad (21)$$

It is evident from Eq. 21 that the temperature change ΔT in the sensing element RS will be equal to the change in ambient temperature $T_2 - T_1$ only if

$$\beta \left[\frac{RC(T_1)}{RS(T_1)} \right] \left[\frac{\alpha_c}{\alpha_s} \right] = 1 \quad (22)$$

Prior art gauges using a temperature sensitive compensating element RC in series with a fixed resistance R for R2 in Fig. 1a provide only partial temperature compensation depending on the choice of β . Commercially available gauges having the design described by Alvesteffer et al., the most recent work on Pirani gauges known to the present inventors, would not satisfy Eq. 22.

As a third problem with prior art gauge designs, the inventors have found that the level of power dissipation in R2 adversely affects accuracy. Prior art Pirani gauges, when configured as in Fig. 1a, have the same pressure dependent current in RS as is in the compensating element at bridge balance. When configured as in Fig. 1b, at balance the same pressure dependent voltage is applied across R2 as across RS. Of course, a pressure dependent current in R2 will cause the temperature of RC to rise above ambient temperature by an amount which varies with pressure.

Prior art Pirani gauges typically use a compensating element of much larger physical dimensions than the sensing

element, to dissipate the heat and thus prevent excessive temperature in the compensating element. As noted above, different physical dimensions for the sensing and compensating elements cause measurement errors when ambient temperature changes.

A fourth problem is that prior art Pirani gauges produce shifts in pressure indications at low pressures when ambient temperature changes. Prior art Pirani gauges have used a variety of components in attempting to maintain the power lost by the sensing element unchanged as ambient temperature changes. For example, in U.S. Pat. 4,682,503 thermoelectric cooling is used to control ambient temperature and thus minimize ambient temperature changes.

In the device disclosed in U.S. Pat. 4,541,286, a thermally sensitive element is mounted adjacent to the compensating arm of the bridge (actually glued to the exterior of the vacuum enclosure in a commercial version). Alvesteffer et al. use an additional element (designated therein as R4) in the bridge to help compensate for the fact that the temperature coefficient of resistance is slightly different for the sensing element at operating temperature, compared to the compensating element at ambient temperature. Although each of these prior art hardware fixes remove some of the errors caused by changes in ambient temperature, none of them removes substantially all of the errors. Thus prior art Pirani gauges produce significant shifts in pressure indications at low pressures when ambient temperature changes.

Another prior system, disclosed in U.S. Patent 5,608,168, links various electrical measurements of the bridge (or approximations thereof) and determines the value or temperature of the temperature dependent resistance, and takes this parameter into account in determining the pressure measurement. However, this system has increased complexity because of the need to measure temperatures or other values.

Thus, there is a need for an improved Pirani-type gauge which overcomes these problems.

SUMMARY OF THE INVENTION

Therefore, it is a general objective of the invention to provide improved apparatus and operating methods for heat loss pressure measurement.

Another general objective of the invention is to provide an improved Pirani-type pressure gauge with a circuit that applies a heating current to a temperature sensing element, without applying the heating current to an associated compensating element.

Another, more specific objective of the invention is to provide an improved Pirani-type pressure gauge wherein a compensating element has physical dimensions substantially equal to those of a sensing element and is located in spaced relationship to the sensing element, in the same plane as the sensing element, and is made of the same material as the sensing element.

A further objective of the invention is to provide an improved heat loss pressure gauge with thermally conductive elements placed near a sensing element to equalize temperatures across the sensing element.

Another objective of the invention is to provide an improved heat loss pressure gauge including a means for maintaining a desired spacing between the sensing element and thermally conductive elements to compensate for expansion and contraction of the sensing element in response to changes in ambient temperature.

Another objective of the invention is to provide an improved pressure gauge wherein physical dimensions and thermal conductivity of heat flow paths of a sensing element are substantially equal to physical dimensions and thermal conductivity of heat flow paths of a compensating element.

It is another objective of the invention to provide an improved heat loss pressure gauge wherein voltage and current in a temperature compensating element are established substantially independently of pressure.

A further objective of the invention is to provide an improved heat loss pressure gauge in which a heating means produces a fixed differential between resistance of a sensing element and resistance of a compensating element at ambient temperature, without applying heating voltage or current to the compensating element.

Another objective is to provide an improved heat loss pressure gauge that uses a DC heating voltage.

An additional general objective of the invention is to provide improved methods of temperature compensation for use in a Pirani-type gauge.

A more specific objective of the invention is to provide an improved method of temperature compensation for use in a Pirani gauge in which sensing device voltage and current values are recorded for a series of pressures and ambient temperatures to define a calibration surface having three or more dimensions.

Another objective of the invention is to provide an improved method of temperature compensation for use in a Pirani gauge wherein accurate calibration can be obtained using a model with only three dimensions, e.g. pressure, voltage, and current.

An additional objective of the invention is to provide an improved method of temperature compensation for use in a Pirani gauge wherein accurate calibration is obtained by identifying an equation of the form $P = f(V, I)$ which approximates collected calibration data, where P is the pressure corresponding to voltage V and current I, and using the equation to calculate the pressure during gauge operation.

Another objective of the invention is to provide an improved method of temperature compensation for use in a Pirani

gauge wherein accurate calibration is obtained by identifying an equation of the form $P = g(W, R)$ which approximates collected calibration data, where P is the pressure corresponding to power W and resistance R , and using the equation to calculate the pressure during gauge operation.

An additional objective of the invention is to provide a heat loss pressure gauge using a bridge circuit with two fixed elements, a sensing element, and a compensating element, wherein resistance of one fixed bridge element multiplied by resistance of the compensating element at a given temperature multiplied by a temperature coefficient of the compensating element for that temperature is substantially equal to the resistance of the other fixed bridge element multiplied by resistance of the sensing element multiplied by the temperature coefficient of the sensing element for the given temperature.

These objectives and others are achieved in the present invention by providing a variety of improvements which cooperate synergistically to provide significantly improved low, mid-range and high pressure measurement accuracy, thus, permitting the range of accurate pressure measurement to be extended to lower and to higher pressures within a single gauge.

As a first improvement, a small diameter wire sensing element is positioned in the same plane as and spaced from a small diameter wire compensating element with two parallel flat thermally conductive plates, each spaced 15 microns from the sensing and compensating elements. In this manner, the inventors have achieved high relative sensitivity in simple geometry without relying on convection. The extreme complexity and cost of microminiature Pirani gauge designs and the several disadvantages of convection cooling of the sensing element are simultaneously avoided.

The inventors have found that this extremely simple, small, and inexpensive measuring means gives results up to atmospheric pressure comparable to those obtained with very complex microminiature Pirani gauges and to those obtained with much larger, position-sensitive convection-cooled Pirani gauges. Surprisingly, this improvement also provides a sensing element with a volume of only 3% that of the sensing element in the microminiature Alvesteffer gauge. The compensating element in the new device has a volume of less than 0.5% of the Alvesteffer-type compensating element.

The present invention also provides improved temperature correction. The inventors have found that the accuracy of low pressure measurement can be significantly improved by better maintaining constant the temperature gradient γ at the ends of the sensing element (see Eqs. 10 and 11). The inventors have found that constancy of γ can be achieved by simultaneously:

1. Using sensing and compensating elements with substantially identical physical dimensions, thermal properties and resistance properties;
2. Using sensing element and compensating element connections with substantially identical physical dimensions, thermal properties and resistance properties;
3. Using element connections with substantially identical and large thermal conductances to a region of substantially uniform temperature for all connections; and
4. Locating the sensing and compensating elements in the same vacuum environment.

In the present invention Eq. 22 is satisfied at all times because the gauge is designed so that

$$RC(T_A) = RS(T_A) \quad (23)$$

where T_A is ambient temperature, and where

$$\alpha_c = \alpha_s \quad (24)$$

$$\beta = 1 \quad (25)$$

Another significant improvement is realized by providing negligible heating in the compensating element. The inventors have modified the conventional Wheatstone bridge to provide independent heating means for the sensing element, while producing substantially zero heating in any of the other three arms of the bridge. Thus, the compensating element can be made with identical dimensions of the sensing element as well as identical physical properties. A DC heating current is used and confined to only the sensing element. A relatively small AC signal is used to sense bridge

balance.

An additional performance improvement is realized by providing a new method of pressure compensation that results in accurate pressure indication at all pressures. In particular, the inventors have discovered that an accurate indication of an unknown pressure P_x at bridge balance may be calculated from a simple equation of the form of Eq. 26.

$$P = f(VS, IS) \quad (26)$$

Where VS is the voltage drop across the sensing element and IS is the current in the sensing element. The particulars of Eq. 26 are derived from paired values of VS_C and IS_C obtained by calibration methods for multiple known values of pressure P_C and ambient temperature spread across the pressure and temperature ranges of interest, using three-dimensional curve fitting software. VS_x and IS_x are measured at the unknown pressure P_x at bridge balance and substituted into Eq. 26. Then, P_x is calculated using a microprocessor or the like.

In this manner, the present invention provides significant advancements in Pirani gauge accuracy, production cost, and package size.

BRIEF DESCRIPTION OF THE DRAWINGS

Figures 1a and 1b are simplified schematic diagrams of conventional Pirani gauges;

Figure 2 is a graph showing the components of heat loss in a conventional Pirani gauge, as discovered through the inventors' research;

Figure 3 is a schematic representation of a conventional Pirani Gauge using a small diameter wire for the sensing element;

Figure 4a is a portion of an improved heat loss gauge according to the present invention, and Figure 4b is a cross-sectional view of the portion shown in Figure 4a;

Figure 5a is an enlarged cross-sectional view of the ends of an improved heat loss gauge according to the present invention, showing support and connection of sensing and compensating elements;

Figure 5b is a cross-sectional view showing one embodiment of a mechanism according to the present invention for maintaining spacing between heat conducting plates and a sensing element and compensating element, respectively; and

Figure 6 is a schematic diagram showing an independent heating arrangement for a sensing element according to the present invention.

DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS

The invention will be described in terms of four categories of improvements to conventional Pirani gauge designs. In a particularly preferred embodiment, the four improvements are used together, and combine synergistically to provide a Pirani gauge having substantially improved performance characteristics.

Improvement 1

The first category of improvements will be discussed with reference to Figures 4a and 4b. Figure 4a is a side view of a portion 10 of an improved heat loss gauge (not to scale). Figure 4b is a sectional view of portion 10 taken along line 4b-4b in Figure 4a. As shown in Figures 4a and 4b, a small diameter wire sensing element 12 is located in the same plane and spaced a distance d from a small diameter wire compensating element 14. Spacing d between sensing element 12 and compensating element 14 is preferably approximately 0.030 in. but may range from 0.010 in. to 0.200 in. Parallel plates 16 and 16' are provided proximate to and parallel to sensing element 12 and compensating element 14.

Parallel plates 16 and 16' are positioned a distance S from sensing element 12 and compensating element 14. S is preferably 0.0007 in. but may range from 0.0002 in. to 0.002 in. Sensing element 12 is made of a material with a high temperature coefficient of resistance, such as pure tungsten, which may be gold plated to help assure a constant emissivity.

The diameter of sensing element 12 is preferably 0.0005 in. but may range from 0.0001 in. to 0.002 in. Although a cylindrical wire shape is preferred, other shapes such as a ribbon may be used for both the sensing and compensating elements. The length of sensing element 12 is preferably 1 in. but may range from 0.25 in. to 3 in.

Compensating element 14 is made of the same material as the sensing element 12 with the same physical dimensions, and with the same thermal and resistance properties.

Portion 10 of the heat loss gauge may be installed in a measuring circuit of the type shown in Fig. 6, in a manner

which will be described in more detail below.

Parallel plates 16 and 16' conduct heat and thereby tend to equalize-temperature gradients along heated sensing element 12 and between the ends of sensing element 12 and compensating element 14. In this manner, the invention achieves high relative sensitivity with a simple structure, and without relying on convection. In this embodiment of the invention, the accuracy of low pressure measurement is significantly improved by using sensing and compensating elements with substantially identical physical dimensions, thermal properties and resistance properties, and locating the sensing and compensating elements in the same vacuum environment. Using this design, the extreme complexity and cost of microminiature Pirani gauge designs and disadvantages associated with convection cooling of the sensing element are simultaneously avoided. This improvement permits pressure measurement results up to atmospheric pressure comparable to those obtained with very complex microminiature Pirani gauges, and comparable to those obtained with much larger, position sensitive convection cooled Pirani gauges.

Improvement 2

As a second broad feature of the invention, an improved mounting arrangement is provided for the sensing and compensating elements. The accuracy of low pressure measurement is significantly improved by using sensing element and compensating element connections with substantially identical physical dimensions, thermal properties and resistance properties, and by using element connections with substantially identical and large thermal conductances to a region of substantially uniform temperature for all connections.

Fig. 5a is a greatly enlarged cross-sectional view of one end of gauge portion 10 where the sensing element 12 is supported by and electrically connected to sensing element connectors 20 and 20' and the compensating element 14 is shown supported by and electrically connected to compensating element connectors 22 and 22'. The section of Fig. 5a is taken along line 5a-5a in Figure 4a. Preferably, identical supports (as shown in Fig. 5a) are provided at each end of gauge portion 10.

Connectors 20, 20', 22 and 22' are preferably made of platinum ribbon, 0.001 in. thick by 0.060 in. wide. Plates 16 and 16' are preferably made of an electrically insulating material with a high thermal conductivity such as aluminum nitride.

Alternatively, sensing and compensating element connectors 20, 20', 22 and 22' can be electrically insulated from the plates 16 by thin electrically insulating layers 24 and 24' which may be a diamond-like coating on tungsten. In this case, Plates 16 and 16' may be made of a high thermal conductivity material such as tungsten. Preferably, the selected material has a thermal conductivity greater than 0.25 watts/cm/K.

Plates 16 and 16' are held in position by simple sheet metal clamps at each end (not shown). The clamps apply sufficient force to the plates 16 and 16' to embed the sensing element 12 and the compensating element 14 into the connectors 20, 20', 22 and 22' until the connectors 20 and 20', and 22 and 22' are in intimate contact. Thus, the spacing S between the sensing element 12 and the surface of the plates 16 and 16' is determined by the diameter of the sensing element and the thickness of the thin ribbon connectors 20, 20', 22, and 22'. This feature of the present invention permits a sensing element smaller than a human hair to be spaced a comparable distance from two flat surfaces, precisely and very inexpensively as well as providing electrical connections to additional circuitry.

Plates 16 and 16' provide a region of substantially uniform temperature, especially when isolated in vacuum with minimal thermal conductivity to the outside world. The thin ribbon connectors 20, 20', 22 and 22' provide identical dimensions, short path and very large thermal conductances to said region of uniform temperature, thus satisfying several of the conditions for constancy of temperature gradient, γ , at the ends of the sensing element.

Sensing element 12 may be suitably tensioned as shown in Fig. 5b by a small diameter wire spring 26 which is loaded during assembly and bears on sensing element 12 adjacent to said connector 21 of sensing element 12. Spring 28 is used in a similar manner to tension the compensating element 14. Springs 26 and 28 serve to maintain precise spacing of the sensing element 12 and compensating element 14 relative to plates 16 and 16' as ambient temperature changes. Sufficient slack must be built into the sensing element 12 and compensating element 14 assemblies to prevent breakage due to differential thermal expansion of the elements 12 and 14 and the plates 16. Without the springs 26 and 28, this slack would change with ambient temperature, thus preventing maintenance of constant spacing S between the parallel plates 16 and 16' and the sensing and compensating elements, respectively, and causing measurement errors.

In the design according to this embodiment of the invention, Eq. 22 is partially satisfied by the fact that sensing element 12 and compensating element 14 are physically, electrically, and thermally identical. In addition, R3 is set equal to R4 in the embodiment of Fig. 6, which from Eq. 6 assures that $\beta = 1$. Thus, Eq. 22 is fully satisfied at all times by this design.

Improvement 3

A third major feature of the invention is an apparatus and method for independently heating sensing element 12. This improvement is illustrated in Fig. 6 wherein a Wheatstone bridge 30 is modified to provide independent heating of sensing element 12. Prior art circuits, used with a compensating element with the same physical dimensions and made of the same material as the sensing element as in the present invention, cause the compensating element to operate not at ambient temperature but at the same temperature as the sensing element. Thus, Pirani gauges with the inventive improvements described above cannot achieve their accuracy potential using prior art heating circuits.

Referring now to Fig. 6, a Wheatstone bridge 30 with nodes A, B, C, and D is provided with sensing element 12 having resistance value R_S , connected between nodes B and C. Non-temperature sensitive resistance element 15 (having resistance R) and compensating element 14 (having resistance R_C) together make up resistance R_2 . R_2 and capacitor 36 are connected in series order between nodes C and D. Resistor 17 having value R_4 is connected between nodes A and B, and resistor 19 having value R_3 is connected between nodes A and D. Vacuum environment 34 encloses sensing element 12 and compensating element 14. AC voltage source 38 is connected between nodes B and D, and frequency selective detector 40 is connected between nodes A and C. DC current source 32 is connected between nodes B and C to provide current to node B. Controller 42 is connected, via automatic feedback linkages 46 and 47, so as to control DC current source 32 and so as to receive a voltage detection input from frequency selective detector 40 for purposes of that control.

Vacuum environment 34 encloses a portion 10 (as shown in Figures 4a and 4b and described above with reference to those Figures) comprising sensing element 12, compensating element 14, and plates 16 and 16'. In addition, the assembly method described previously with reference to Figs. 5a and 5b is preferably used in the circuit of Fig. 6. Element connectors 20 and 20' at one end of sensing element 12 (shown in Fig. 5a) are electrically connected to Point C in bridge circuit 30 of Fig. 6, while sensing element connectors 21 and 21' (not shown) at the other end of sensing element 12 are electrically connected to Point B in Fig. 6. Compensating element connectors 22 and 22' at one end of compensating element 14 (shown in Fig. 5a) are electrically connected through capacitor 36 to Point D in Fig. 6, while the other end of compensating element 14 is connected to compensating element connectors 23 and 23' which are connected through a resistance 15 to Point C.

As shown in Fig. 6, DC current source 32 furnishes heating current I to sensing element 12 which is located in the vacuum environment 34. A capacitor 36 is provided as a means for preventing current from current source 32 from being present in R_2 , R_3 and R_4 . Thus, unlike prior art Pirani gauges using a conventional Wheatstone bridge, no portion of the heating current or heating voltage in R_S is present in R_2 at any time.

AC voltage source 38 applies an AC signal voltage to bridge 30 producing AC signal currents i_S , i_2 , i_3 , and i_4 . Using very small values for i_S , i_2 , i_3 , and i_4 and frequency selective detector 40, bridge balance can be detected with negligible heating produced in any arm of bridge 30. The DC current I from source 32 is automatically adjusted by controller 42, so as to continually assure that the AC voltage drop $i_S R_S$ from point B to C is equal to the voltage drop $i_4 R_4$ from B to A as measured by the AC voltage detecting function of frequency selective detector 40. This automatic feedback linkage is indicated by dashed lines 46 and 47.

Processor 51 is connected to current meter 49 and to voltage meter 48, and produces an output indicative of pressure in the vacuum environment 34 based on the level of heating current and through sensing element 12 and the voltage drop across sensing element 12.

Thus, compensating element 14 may be made with the same physical dimensions and thermal and resistance properties as sensing element 12 and still operate at ambient temperature without any pressure dependent electrical heating.

Improvement 4

A fourth improvement will be described with reference again to Fig. 6. In this improvement, an improved apparatus and method are provided for calibrating and operating the Pirani gauge according to the present invention.

The inventors have discovered that an accurate indication of an unknown pressure P_x at bridge balance may be calculated from a simple equation of the form of Eq. 26.

$$P = f(V_S, I_S) \quad (26)$$

This finding differs from more conventional approaches. Pressure indication has been considered to depend not only on resistance of the sensing element, but also on other factors such as ambient temperature. Thus, conventional cali-

bration schemes often require measurements of resistance and other quantities, both for calibration and during operation. However, the inventors have discovered that when the improvements described above are made, the values of VS and IS incorporate sufficient temperature information to produce an accurate pressure output, so that it is possible to eliminate the steps of separately measuring other parameters such as ambient temperature. In this manner, it is possible to use a three dimensional calibration table to determine pressure based on voltage and current alone.

In order to calibrate the gauge shown in Fig. 6, sensing element 12 is exposed to a series of known representative pressures and ambient temperatures spread over the pressure and temperature ranges of interest. The voltage drop, VS_C , as measured by voltmeter 48 and the current, IS_C , as measured by current meter 49 are recorded together at bridge balance with each of the known representative calibration pressures, P_C . These values may be recorded by a program operating in processor 51 or may be transferred to another processing unit for calibration calculations. The pressure P_C is plotted against voltage VS_C and current IS_C . Each series of measurements at a given calibration temperature produces a constant temperature function relating pressure to voltage and current. Significantly, as noted above, the inventors have discovered that these constant temperature functions can be usefully combined in a single three-dimensional data table to define a single calibration function of the form of Eq. 26. When this is done, the result is a series of points defining a surface, where the height of the surface is the pressure and is a function of measured voltage and current values.

The resulting calibration data may be stored in a lookup table and measured pressures can be determined by interpolating between pressure values stored in the lookup table based on the measured voltage drop and current. However, because of the number of points that must be stored to produce accurate output over a wide range of pressures, in the preferred embodiment, an approximating equation is obtained for the surface on which the measured values lie. This can readily be accomplished using three-dimensional surface plotting software. The resulting equation is of the form shown in Eq. 26. Then, to measure an unknown pressure P_X at any temperature, VS_X is measured by voltmeter 48 and IS_X is measured by current meter 49 at bridge balance. The correct value of pressure can then be readily obtained by substitution in Eq. 26 giving

$$P_X = f(VS_X, IS_X) \quad (27)$$

For convenience, Eq. 27 can be stored in processor 51 which can then be used to automatically calculate P_X when VS_X and IS_X are input to processor 51.

Those skilled in the art will appreciate that other quantities could be substituted for voltage and current within the scope of this invention. For example, a function of the form $P_X = g(W, R)$ where W is power applied to sensing element 12 and R is the resistance of sensing element 12 could be used in place of Equation 27. In this case, W and R can be calculated from the output of voltmeter 48 and current meter 49. What is important is that the two selected parameters include information relating to both current and voltage, such that the effects of changes in current and voltage will be differentially reflected in the calibration graph or table created based on values of the two parameters. Thus, for example, the two input parameters for the function may be any two of a group including: power, current, voltage, and resistance. To generalize, it is possible to identify an equation of the form

$$P = h(X, Y)$$

which approximates the calibration surface, where X is the first input parameter, Y is the second input parameter, and P is the pressure corresponding to values of the first parameter X and second parameter Y . This equation is then used as a proxy for the multi-dimensional calibration surface to calculate the pressure.

This improvement provides excellent temperature compensation from 0°C to 50°C from pressures less than 10^{-4} Torr to above atmospheric pressure. It avoids the need to measure power and temperature as is sometimes done. It compensates for all types of ambient temperature change induced errors, such as change in radiation loss, not merely those losses dependent on changes in sensing element to wall temperature changes as is the case in U.S. Pat. 4,682,503. The improvement avoids the complexity of having to control the ambient temperature using thermoelectric cooling as described in U.S. Pat. 5,347,869. In addition, this improved calibration and operating method automatically compensates for the fact that the temperature coefficient of resistivity will be slightly different for the sensing element at operating temperature than for the compensating element at ambient temperature.

Claims

1. A heat loss gauge for measuring gas pressure in an environment, comprising:

a temperature-responsive sensing element;
 a temperature-responsive compensating element;
 heating means connected to the sensing element for applying power to the sensing element to heat said sensing element; and
 5 measuring means connected to the sensing element and the compensating element for determining gas pressure in the environment based on temperatures of the sensing element and compensating element and producing an electrical signal output indicative of the determined gas pressure,
 wherein the compensating element has physical dimensions substantially equal to those of said sensing element and is located in spaced relationship to said sensing element and in the same plane as said sensing element
 10 and is made of the same material as said sensing element.

2. The heat loss gauge of claim 1 wherein the gauge further comprises first and second thermally conductive elements, said first and second thermally conductive elements respectively having first and second surfaces proximate to said sensing element.

3. The heat loss gauge of claim 2 wherein said sensing element has a spacing of from 0.0002 in. to 0.002 in. from each of said first and second surfaces.

4. The heat loss gauge of claim 2 wherein said spacings between said sensing element and said surfaces are substantially equal.

5. The heat loss gauge of claim 2 wherein said surfaces of said thermally conductive elements are made of a material with a thermal conductivity greater than 0.25 watts/cm/K.

6. The heat loss gauge of claim 3 wherein the gauge further includes means for maintaining equal spacings between said sensing element and said surfaces despite ambient temperature changes.

7. The heat loss gauge of claim 6 wherein said means for maintaining equal spacings includes a spring device for maintaining tension in said sensing element.

8. The heat loss sensor of claim 1 wherein said gauge includes a bridge circuit having four arms: a first arm including said sensing element, a second arm including said compensating element, and third and fourth arms,
 wherein said third and fourth arms have equal impedances, and the bridge circuit includes means for preventing application to the compensating element of said power applied to the sensing element by the heating means.

9. A heat loss gauge for measuring gas pressure in an environment, comprising:

a temperature-responsive sensing element extending between mountings at ends thereof and having heat flow paths between the mountings and a region of substantially uniform temperature therebetween;
 a temperature-responsive compensating element extending between mountings at ends thereof and having heat flow paths between the mountings and a region of substantially uniform temperature therebetween;
 heating means connected to the sensing element for applying power to the sensing element to heat said sensing element; and
 45 measuring means connected to the sensing element and the compensating element for determining gas pressure in the environment based on temperatures of the sensing element and compensating element and producing an electrical signal output indicative of the determined gas pressure,
 wherein physical dimensions and thermal conductivity of said heat flow paths of said sensing element are substantially equal to physical dimensions and thermal conductivity of said heat flow paths of said compensating element.

10. A heat loss gauge for measuring gas pressure in an environment, comprising:

a resistive sensing element having a resistance which changes in response to ambient temperature changes;
 55 a compensating element carrying an electrical current and having a resistance which changes in response to ambient temperature changes;
 heating means connected to the sensing element for heating the sensing element to produce a fixed differential between the resistance of the sensing element and a resistance of the compensating element at ambient tem-

perature; and

measuring means connected to the sensing element and the compensating element for determining gas pressure in the environment based on relative temperatures of the sensing element and compensating element and producing an electrical signal output indicative of the determined gas pressure,
 5 wherein the current in the compensating element is substantially independent of pressure.

11. A heat loss gauge for measuring gas pressure in an environment, comprising:

10 a resistive sensing element having a resistance which changes in response to ambient temperature changes;
 a compensating element having a resistance which changes in response to ambient temperature changes;
 heating means connected to the sensing element for applying a heating voltage to the sensing element; and
 measuring means connected to the sensing element and the compensating element for determining gas pressure in the environment based on relative temperatures of the sensing element and compensating element
 15 and producing an electrical signal output indicative of the determined gas pressure,
 wherein said heating means operates to produce a fixed differential between the resistance of the sensing element and a resistance of the compensating element at ambient temperature without applying the heating voltage to the compensating element.

12. The heat loss gauge of claim 11 wherein the heating voltage is a DC voltage.

13. A heat loss gauge for measuring gas pressure in an environment, comprising:

20 a resistive sensing element having a resistance which changes in response to ambient temperature changes;
 a compensating element carrying an electrical current and having a resistance which changes in response to
 25 ambient temperature changes;
 heating means connected to the sensing element for applying a heating current to the sensing element; and
 measuring means connected to the sensing element and the compensating element for determining gas pressure in the environment based on relative temperatures of the sensing element and compensating element
 30 and producing an electrical signal output indicative of the determined gas pressure,
 wherein said heating means operates to produce a fixed differential between the resistance of the sensing element and a resistance of the compensating element at ambient temperature without applying the heating current to the compensating element.

14. The heat loss gauge of claim 13 wherein the heating current is a DC current.

15. A method of providing temperature compensation in a Pirani gauge including the steps of:

35 (1) exposing the gauge to a series of known representative pressures;
 (2) recording calibration data including values representing the voltage and current required to maintain a
 40 sensing element in the gauge at a desired temperature for each said pressure;
 (3) repeating steps (1) and (2) at selected ambient temperatures such that said calibration data defines points on a calibration surface having at least three dimensions; and
 (4) using said recorded calibration data to calculate an unknown pressure by measuring the voltage and current required to heat said sensing element to the desired temperature when said sensing element is exposed
 45 to said unknown pressure, and determining the pressure corresponding to that voltage and current based on the calibration surface.

16. The method of claim 15 including the further step of identifying an equation of the form

$$P=f(V, I)$$

50 which approximates said surface, where P is the pressure corresponding to voltage V and current I, and using said equation in step (4) as a proxy for the calibration surface to calculate the pressure.

17. The method of claim 15 wherein values proportional to said voltage and said current are used to represent said
 55 voltage and current.

18. A method of providing temperature compensation in a Pirani gauge having a sensing element, including the steps

of:

(1) selecting a first parameter and a second parameter from the group consisting of heating power, current, voltage, and resistance, said second parameter different from said first parameter;
 (2) exposing the gauge to a series of known representative pressures at a known ambient temperature;
 (3) recording a value of said first parameter required to maintain the sensing element in the gauge at a desired temperature for each of said known pressures at said known ambient temperature;
 (4) recording a value of said second parameter in the sensing element in said gauge at each of said known pressures and values of said first parameter;
 (5) repeating steps (2), (3) and (4) at a plurality of ambient temperatures to define a multidimensional pressure calibration surface which is a function of the first parameter and the second parameter; and
 (6) using said recorded calibration data to calculate an unknown pressure by measuring said first parameter and said second parameter required to heat said sensing element to the desired temperature when said sensing element and said compensation element are exposed to said unknown pressure, and determining the pressure corresponding to that first parameter and second parameter based on the multidimensional calibration surface.

19. The method of claim 18 wherein said first parameter is heating power and said second parameter is resistance.

20. The method of claim 19 including the further step of identifying an equation of the form

$$P=g(W,R)$$

which approximates said calibration surface, where P is the pressure corresponding to heating power W and resistance R, and using said equation in step (6) as a proxy for the multi-dimensional calibration surface to calculate the pressure.

21. The method of claim 18 wherein one of the first and second parameters is heating power and a value proportional to said heating power is used to represent said heating power.

22. The method of claim 18 wherein one of the first and second parameters is resistance and a value proportional to said resistance is used to represent said resistance.

23. The method of claim 18 including the further step of identifying an equation of the form

$$P=h(X,Y)$$

which approximates said calibration surface, where X is said first parameter, Y is said second parameter, and P is the pressure corresponding to values of said first parameter X and second parameter Y, and using said equation in step (6) as a proxy for the multi-dimensional calibration surface to calculate the pressure.

24. A heat loss pressure gauge comprising:

a bridge circuit including a first arm having a first temperature sensitive resistance element, a second arm having a second temperature sensitive resistance element, a third arm having a third fixed resistance element and a fourth arm having a fourth fixed resistance element;
 voltage means for applying an adjustable voltage across said first and second elements and across said third and fourth elements; and
 heating means connected to the first element for applying power to the first element to heat said first element;
 wherein the resistance of said fixed fourth element multiplied by the resistance of said second element at a given temperature multiplied by a temperature coefficient of said second element for said given temperature is substantially equal to the resistance of said fixed third element multiplied by the resistance of said first element multiplied by the temperature coefficient of said first element for said given temperature, and
 wherein said bridge circuit includes means for preventing application to the second element of said power applied to the first element by the heating means.

FIG. 1A

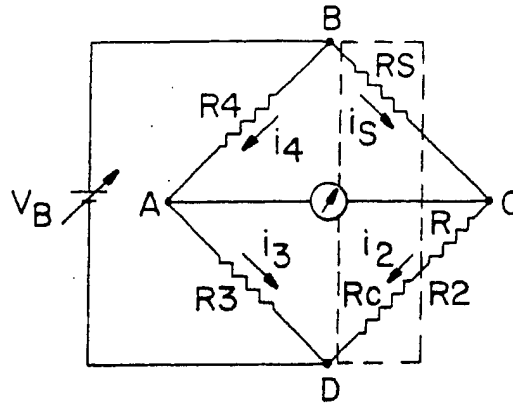


FIG. 1B

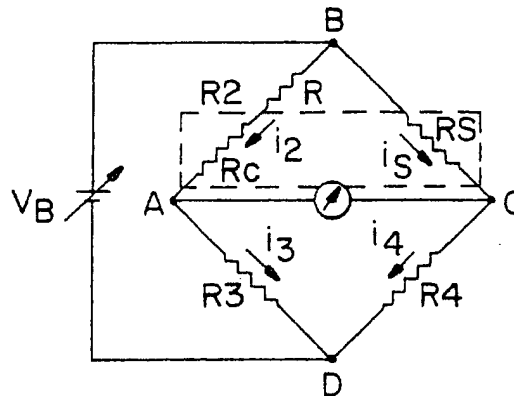


FIG. 2

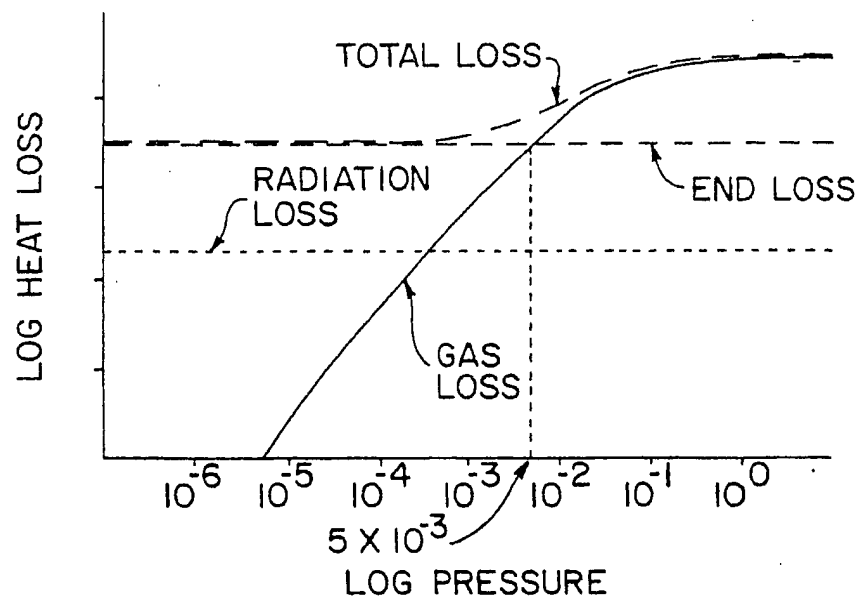


FIG. 3
PRIOR ART

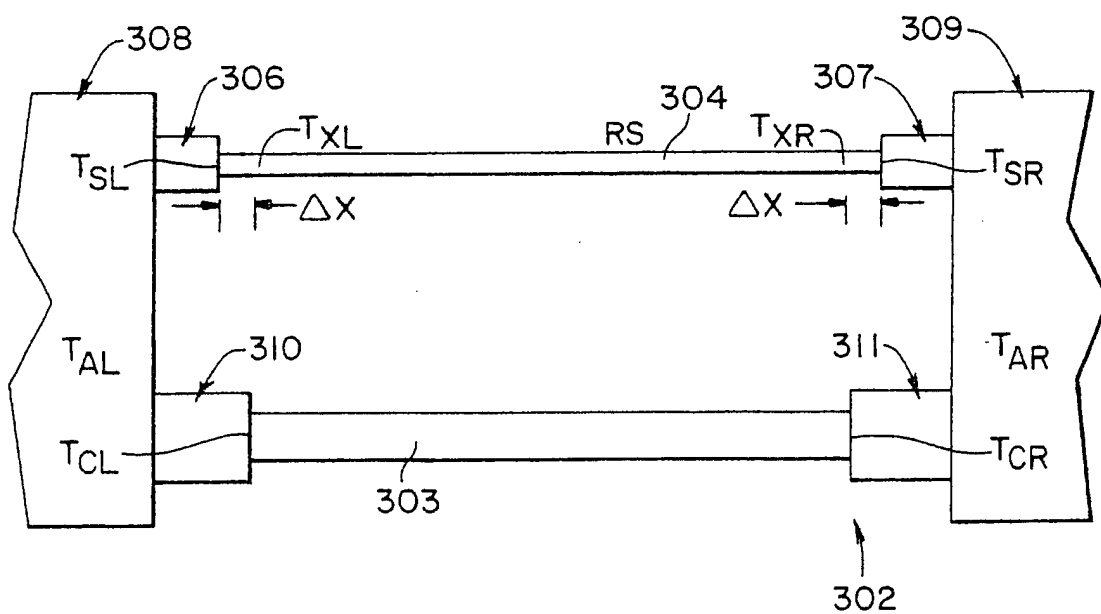


FIG. 4A

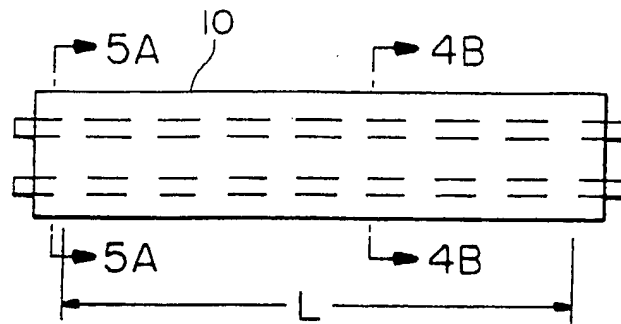


FIG. 4B

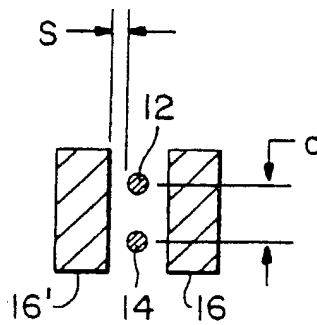


FIG. 5A

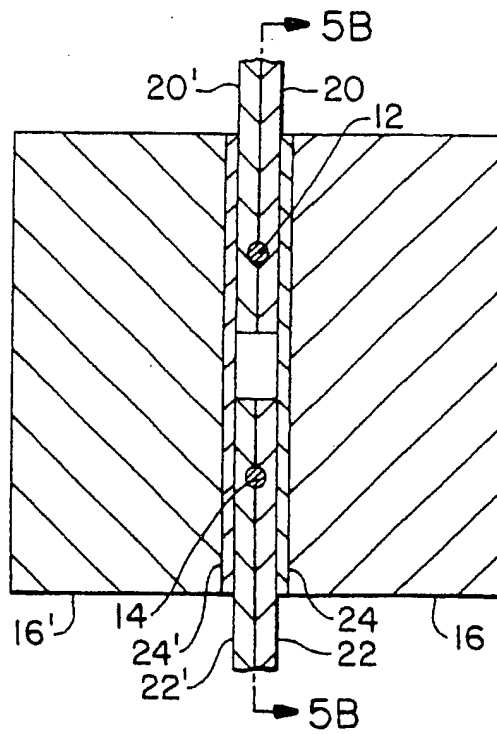


FIG. 5B

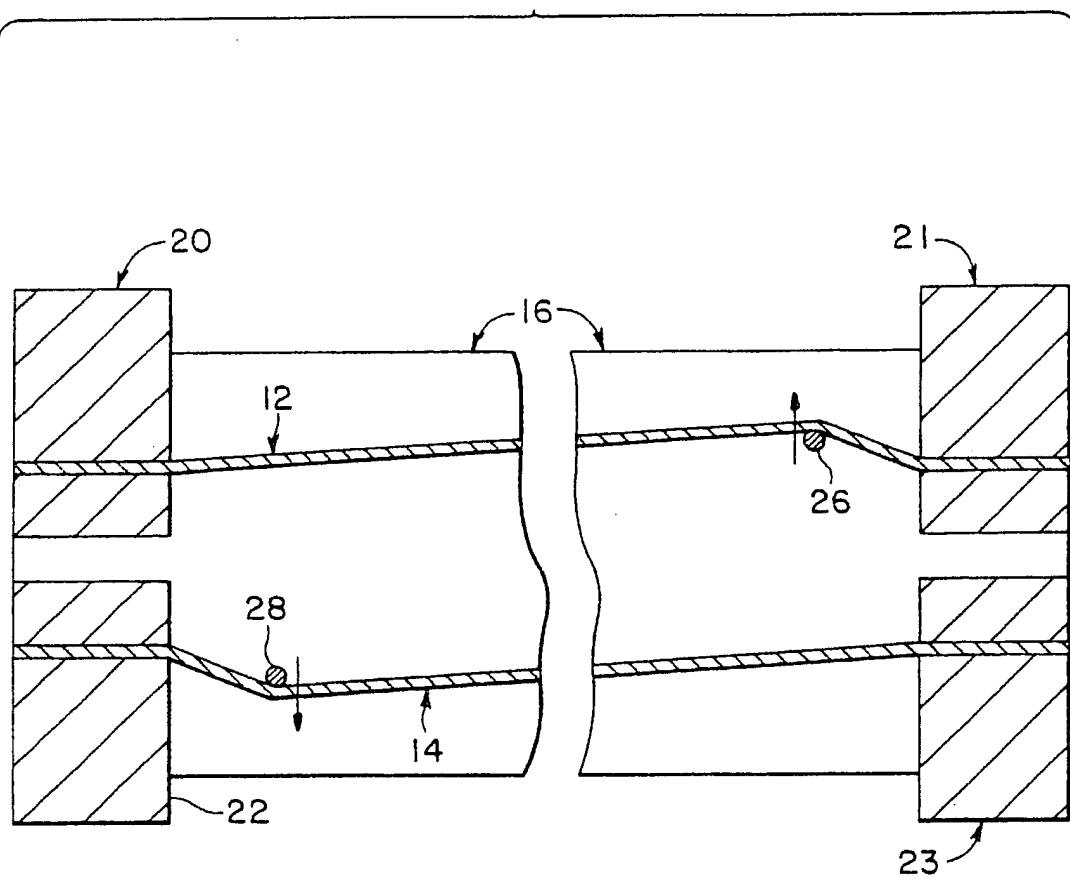
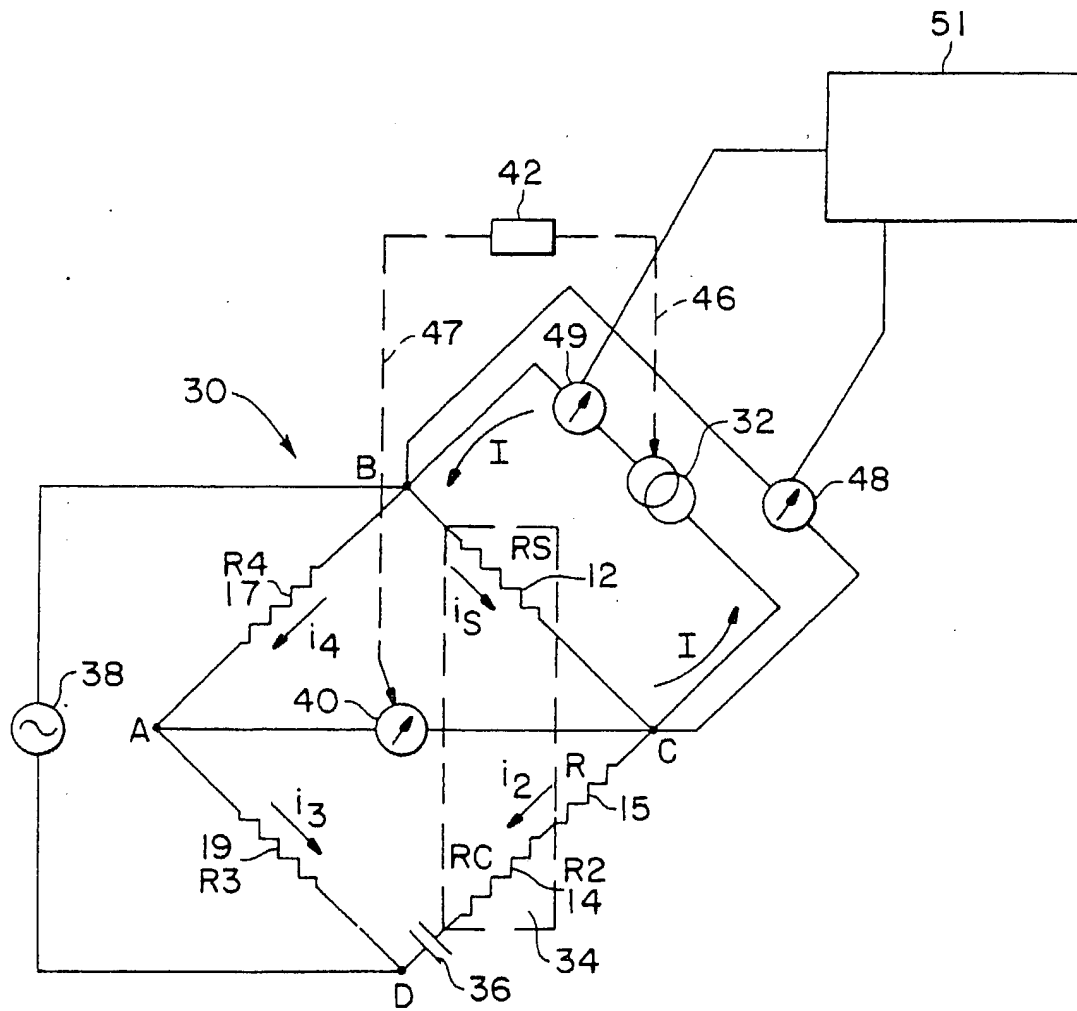


FIG. 6





European Patent
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EUROPEAN SEARCH REPORT

Application Number

EP 98 10 2089

DOCUMENTS CONSIDERED TO BE RELEVANT			
Category	Citation of document with indication, where appropriate, of relevant passages	Relevant to claim	CLASSIFICATION OF THE APPLICATION (Int.Cl.6)
X,D	US 5 347 869 A (SHIE ET AL.) 20 September 1994 * column 7, line 31 - line 38 * * column 8, line 58 - column 9, line 8; figure 6C *	1,9	G01L21/12
A	US 5 557 972 A (JACOBS ET AL.) 24 September 1996 * column 3, line 42 - line 55; figure 4 *	1,9	
A	US 5 597 957 A (SCHIEFERDECKER ET AL.) 28 January 1997 * column 3, line 33 - line 63; figure 1 *	1,9	
A	DE 10 94 341 A (ELECTRODYNAMICS) 8 December 1960 * column 1, line 29 - line 40 *	10,11, 13,15	
A	DE 16 48 592 A (LEYBOLD-HERAEUS) 1 April 1971 * claims 1,2 *	24	
			TECHNICAL FIELDS SEARCHED (Int.Cl.6)
			G01L
The present search report has been drawn up for all claims			
Place of search MUNICH		Date of completion of the search 20 March 1998	Examiner Mielke, W
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